

# MSKSEMI

SEMICONDUCTOR



ESD



TVS



TSS



MOV

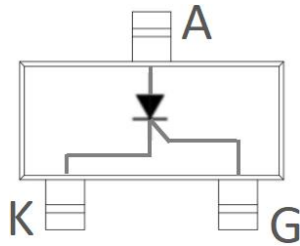


GDT



PLED

Product data sheet



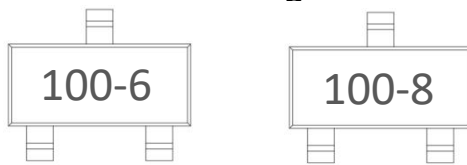
**Features**

Blocking voltage to 600V (400V @MCR100-6).  
RMS on-state current to 0.8A.

**Features**

General purpose switching.  
Phase control applications.  
Solid state relays.

**Marking**



**Absolute Maximum Ratings(Ta=25°C)**

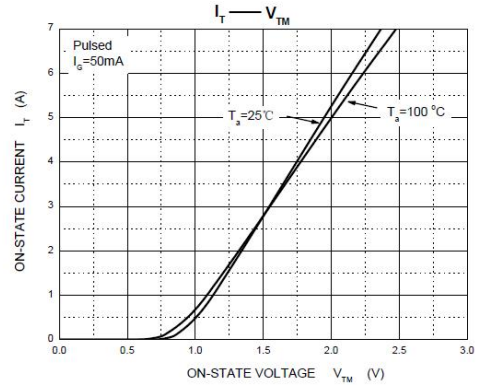
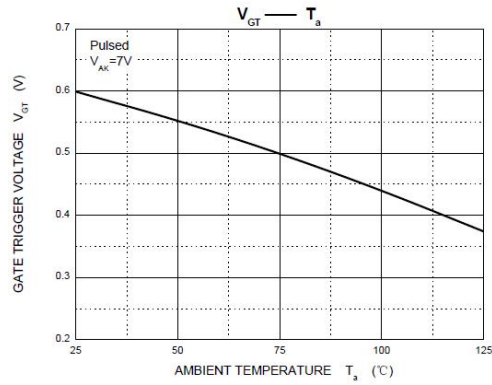
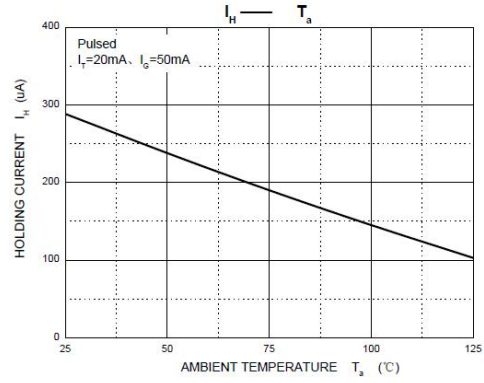
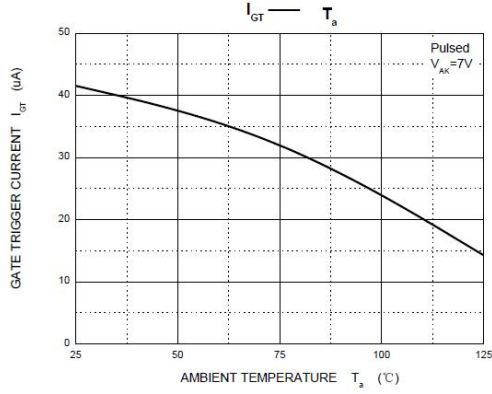
Symbol	Parameter	Part	Value	Unit
V <sub>DRM</sub>	Repetitive peak off-state voltage	MCR100-6	400	V
V <sub>RPM</sub>	Repetitive peak reverse voltage	MCR100-8	600	V
V <sub>EBO</sub>	Emitter-Base Voltage		7	V
I <sub>T(RMS)</sub>	RMS on-state current(T=60°C)		0.8	A
I <sub>TSM</sub>	Non repetitive surge peak on-state current(tp=10ms)		8	A
I <sub>GM</sub>	Peak gate current (tp=20µs, T <sub>j</sub> =110°C)		0.2	A
P <sub>GM</sub>	Peak gate power (tp=20µs, T <sub>j</sub> =110°C)		500	mW
P <sub>G(AV)</sub>	Average gate power dissipation(T <sub>j</sub> =110°C)		100	mW
T <sub>J</sub>	Operation Junction Temperature Range		-40~+110	°C
T <sub>stg</sub>	Storage Temperature Range		-40~+150	°C

**Electrical Characteristics (Ta=25°C unless otherwise specified)**

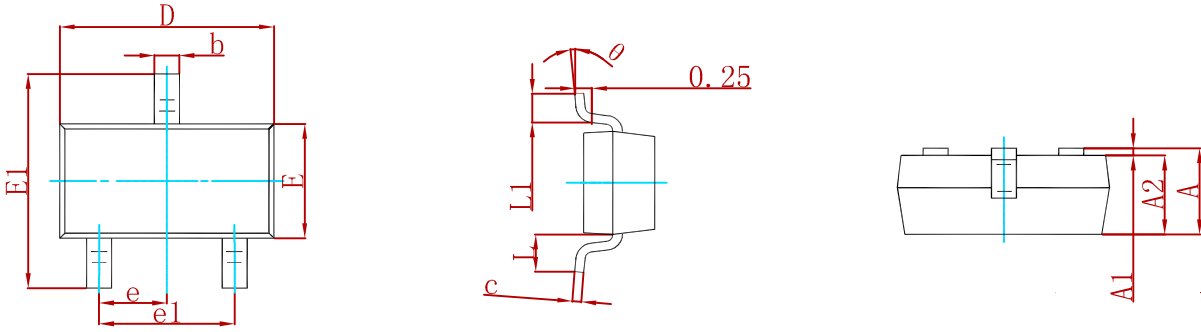
Symbol	Parameter	Test conditions	Part	Min	Typ	Max	Unit
V <sub>TM</sub>	On state voltage	I <sub>TM</sub> =1A , tp=380µS				1.7	V
V <sub>GT</sub>	Gate trigger voltage	V <sub>AK</sub> =7V				0.8V	V
V <sub>(BR)EBO</sub>	Peak Repetitive forward and Reverse blocking voltage	I <sub>DRM</sub> /I <sub>RPM</sub> =100µA	MCR100-6 MCR100-8	400 600			V
I <sub>DRM</sub> I <sub>RPM</sub>	Peak forward or reverse blocking Current	V <sub>AK</sub> =V <sub>DRM</sub> OR V <sub>RPM</sub>				10	µA
I <sub>H</sub>	Holding current	I <sub>HL</sub> =20mA , V <sub>AK</sub> =7V				5	mA
I <sub>GT</sub>	Gate trigger current	V <sub>AK</sub> =7V		15		60	µA

\* Forward current applied for 1 ms maximum duration duty cycle1%.

**Typical Characteristics**

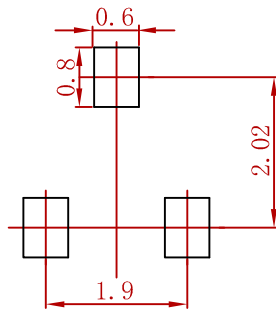


**PACKAGE MECHANICAL DATA**



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

**Suggested Pad Layout**



- Note:
1. Controlling dimension: in millimeters.
  2. General tolerance: ± 0.05mm.
  3. The pad layout is for reference purposes only.

**REEL SPECIFICATION**

P/N	PKG	QTY
MCR100-6 MCR100-8	SOT-23	3000

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